NSN 5998-01-237-3645

Circuit Card Assembly - Page 1 of 1



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End Application:

8888-00-888-1987

Special Features:

Mark serial nr approx where indicated per find nr 11; component markingsneed not be visible after assembly; reference designations per schematic diagram find nr 30 and do not appear on parts; flare find nr 16 this side to be flush or below surface of find nr 1; coat both sides per find nr 19; parts shall meet requirements of mil-std-454; board matl mil-p-13949 type gfn plastic sheet copper clad internal layers 2 ounce copper external layers 1 ounce copper mil-p-13949/12 type pcgf glass cloth b-stage; board construction external conductive layer .0022 min copper thk after plating tin lead plating fused .0003 min thk when measured at crest

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

Yes - demil/mli

Fiig:

A511k0